## **INTEGRATED CIRCUITS**

# DATA SHEET



# **74LV14**Hex inverting Schmitt-trigger

Product specification Supersedes data of 1997 Feb 03 IC24 Data Handbook





# **Hex inverting Schmitt-trigger**

74LV14

### **FEATURES**

- Wide operating voltage: 1.0 to 5.5 V
- Optimized for Low Voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between V<sub>CC</sub> = 2.7 V and V<sub>CC</sub> = 3.6 V
- Typical V<sub>OLP</sub> (output ground bounce) < 0.8 V at V<sub>CC</sub> = 3.3 V,  $T_{amb} = 25^{\circ}C.$
- Typical V<sub>OHV</sub> (output V<sub>OH</sub> undershoot) > 2 V at V<sub>CC</sub> = 3.3 V,  $T_{amb} = 25^{\circ}C.$
- Output capability: standard
- I<sub>CC</sub> category: SSI

### **APPLICATIONS**

Wave and pulse shapers for highly noisy environments

### **DESCRIPTION**

The 74LV14 is a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC/HCT14.

The 74LV14 provides six inverting buffers with Schmitt-trigger action. It is capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

### **QUICK REFERENCE DATA**

GND = 0 V;  $T_{amb} = 25^{\circ}C$ ;  $t_r = t_f \le 2.5 \text{ ns}$ 

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
	Propagation delay nA to nY	C <sub>L</sub> = 15 pF; V <sub>CC</sub> = 3.3 V	13	ns
C <sub>I</sub>	Input capacitance	4 1º C	3.5	pF
$C_{PD}$	Power dissipation capacitance per gate	See Notes 1 and 2	15	pF

### NOTES:

- 1.  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ )  $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum_i (C_L \times V_{CC}^2 \times f_o)$  where:  $f_i$  = input frequency in MHz;  $C_L$  = output load capacitance in pF;  $f_o$  = output frequency in MHz;  $V_{CC}$  = supply voltage in V;  $V_{CC} \times V_{CC}^2 \times f_o$ ) = sum of the outputs.
- 2. The condition is  $V_I = GND$  to  $V_{CQ}$

### ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
14-Pin Plastic DIL	-40°C to +125°C	74LV14 N	74LV14 N	SOT27-1
14-Pin Plastic SO	-40°C to +125°C	74LV14 D	74LV14 D	SOT108-1
14-Pin Plastic SSOP Type II	-40°C to +125°C	74LV14 DB	74LV14 DB	SOT337-1
14-Pin Plastic TSSOP Type I	-40°C to +125°C	74LV14 PW	74LV14PW DH	SOT402-1

### **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 3, 5, 9, 11, 13	1A – 6A	Data inputs
2, 4, 6, 8, 10, 12	1Y – 6Y	Data outputs
7	GND	Ground (0 V)
14	V <sub>CC</sub>	Positive supply voltage

### **FUNCTION TABLE**

INPUT	OUTPUT
nA	nY
L	Н
Н	L

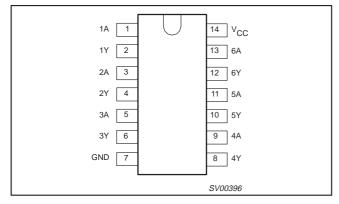
### NOTES:

H = HIGH voltage level L = LOW voltage level

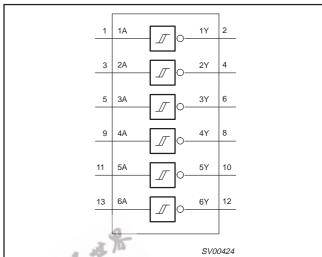
# Hex inverting Schmitt-trigger

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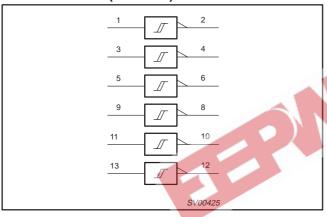
### **PIN CONFIGURATION**



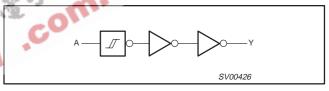
### LOGIC SYMBOL



### LOGIC SYMBOL (IEEE/IEC)



# LOGIC DIAGRAM



### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
V <sub>CC</sub>	DC supply voltage	See Note1	1.0	3.3	5.5	V
V <sub>I</sub>	Input voltage		0	-	V <sub>CC</sub>	V
V <sub>O</sub>	Output voltage		0	_	V <sub>CC</sub>	V
T <sub>amb</sub>	Operating ambient temperature range in free air	See DC and AC characteristics	-40 -40		+85 +125	°C

### NOTE:

<sup>1.</sup> The LV is guaranteed to function down to  $V_{CC} = 1.0V$  (input levels GND or  $V_{CC}$ ); DC characteristics are guaranteed from  $V_{CC} = 1.2V$  to  $V_{CC} = 5.5V$ .

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### ABSOLUTE MAXIMUM RATINGS1, 2

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +7.0	V
± I <sub>IK</sub>	DC input diode current	$V_{I} < -0.5 \text{ or } V_{I} > V_{CC} + 0.5V$	20	mA
± I <sub>OK</sub>	DC output diode current	$V_{O} < -0.5 \text{ or } V_{O} > V_{CC} + 0.5V$	50	mA
± I <sub>O</sub>	DC output source or sink current  – standard outputs	$-0.5V < V_O < V_{CC} + 0.5V$	25	mA
± I <sub>GND</sub> , ± I <sub>CC</sub>	DC V <sub>CC</sub> or GND current for types with – standard outputs		50	mA
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C
P <sub>TOT</sub>	Power dissipation per package  – plastic DIL  – plastic mini-pack (SO)  – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

### NOTES:

### DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	-40	0°C to +8	5°C	-40°C to	+125°C	UNIT
			MIN	TYP <sup>1</sup>	MAX	MIN	MAX	1
	1	$V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 100 \mu A$		1.2				
		$V_{CC} = 2.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 100\mu A$	1.8	2.0		1.8		1
$V_{OH}$	HIGH level output voltage; all outputs	$V_{CC} = 2.7V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 100\mu A$	2.5	2.7		2.5		V
		$V_{CC} = 3.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ , $-I_O = 100\mu A$	2.8	3.0		2.8		]
		$V_{CC} = 4.5V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 100\mu A$	4.3	4.5		4.3		
V <sub>OH</sub>	HIGH level output voltage;	$V_{CC} = 3.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 6mA$	2.40	2.82		2.20		
*OH	STANDARD outputs	$V_{CC} = 4.5V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $-I_O = 12mA$	3.60	4.20		3.50		
		$V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		0				
	L OWN Level and and	$V_{CC} = 2.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 100\mu A$		0	0.2		0.2	
$V_{OL}$	LOW level output voltage; all outputs	$V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		0	0.2		0.2	V
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		0	0.2		0.2	
		$V_{CC} = 4.5V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 100\mu A$		0	0.2		0.2	
V <sub>OL</sub>	LOW level output voltage;	$V_{CC} = 3.0V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 6mA$		0.25	0.40		0.50	V
VOL	STANDARD outputs	$V_{CC} = 4.5V$ ; $V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 12mA$		0.35	0.55		0.65	ľ
I <sub>I</sub>	Input leakage current	$V_{CC} = 5.5V$ ; $V_I = V_{CC}$ or GND			1.0		1.0	μА
I <sub>CC</sub>	Quiescent supply current; SSI	$V_{CC} = 5.5V; V_{I} = V_{CC} \text{ or GND}; I_{O} = 0$			20.0		40	μА
Δl <sub>CC</sub>	Additional quiescent supply current	$V_{CC} = 2.7V \text{ to } 3.6V; V_I = V_{CC} - 0.6V$			500		850	μΑ

### NOTE:

Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
 The input and output voltage ratings may be asceeded if the input and output voltage ratings may be asceeded if the input and output voltage ratings may be asceeded.

<sup>2.</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>1.</sup> All typical values are measured at T<sub>amb</sub> = 25°C.

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### TRANSFER CHARACTERISTICS

Voltages are referenced to GND (ground = 0 V)

				T <sub>amb</sub> (°C)				Т	EST CONDITIONS
SYMBOL	PARAMETER		-40 TO +85		–40 TC	+125	UNIT	V <sub>CC</sub>	WAVEFORMS
		MIN.	TYP.	MAX.	MIN.	MIN.		(V)	WAVEFORWIS
		-	0.70	-	_	-		1.2	
		0.8	1.10	1.4	0.8	1.4		2.0	
		1.0	1.45	2.0	1.0	2.0		2.7	
$V_{T+}$	Positive-going threshold	1.2	1.60	2.2	1.2	2.2	V	3.0	Figure 1 and 2
	uncanola	1.5	1.95	2.4	1.5	2.4		3.6	
		1.7	2.50	3.15	1.7	3.15		4.5	
		2.1	3.00	3.85	2.1	3.85		5.5	
		-	0.34	-	-	-		1.2	
	Negative-going threshold	0.3	0.65	0.9	0.3	0.9	- 0	2.0	
		0.4	0.90	1.4	0.4	1.4	V	2.7	
$V_{T-}$		0.6	1.05	1.5	0.6	1.5		3.0	Figure 1 and 2
	l in concid	0.8	1.30	1.8	0.8	1.5 1.8		3.6	
		0.9	1.60	2.0	0.9	2.0	100	4.5	
		1.1	2.00	2.6	1.1	2.6		5.5	
		_	0.30	A =	-	0-		1.2	
		0.2	0.55	0.8	0.2	0.8		2.0	
		0.3	0.60	1.1	0.3	1.1		2.7	
$V_{H}$	Hysteresis (V <sub>T+</sub> – V <sub>T-</sub> )	0.4	0.65	1.2	0.4	1.2	V	3.0	Figure 1 and 2
	(-1+ -1-)	0.4	0.70	1.2	0.4	1.2		3.6	
		0.4	0.80	1.4	0.4	1.4		4.5	
		0.6	1.00	1.5	0.6	1.5		5.5	

### NOTES:

- All typical values are measured at T<sub>amb</sub> = 25°C
   The V<sub>IH</sub> and V<sub>IL</sub> from the DC family characteristics are superseded by the V<sub>T+</sub> and V<sub>T-</sub>.

### **AC CHARACTERISTICS**

 $GND = 0V; \, t_r \leq t_f = 2.5 ns; \, C_L = 50 pF; \, R_L = 1 K\Omega$ 

			CONDITION			LIMITS						
SYMBOL	PARAMETER	WAVEFORM	CONDITION		40 to +85 °	С	–40 to +	UNIT				
		V <sub>CC</sub> (V)	MIN	TYP <sup>1</sup>	MAX	MIN	MAX					
			1.2		80							
			2.0		27	37		48				
t <sub>PHL/PLH</sub>	Propagation delay nA to nY	Figure 6	Figure 6	2.7		20	28		35	ns		
			3.0 to 3.6		15 <sup>2</sup>	22		28				
			4.5 to 5.5			18		23				

- 1. Unless otherwise stated, all typical values are measured at  $T_{amb}$  = 25°C 2. Typical values are measured at  $V_{CC}$  = 3.3 V.

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### TRANSFER CHARACTERISTIC WAVEFORMS

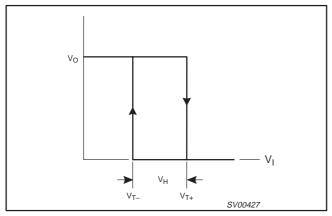


Figure 1. Transfer characteristic.

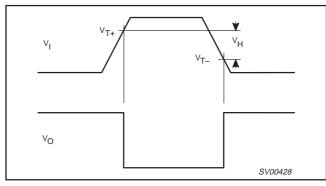


Figure 2. Definition of  $\nu_{T\,+}$  ,  $V_{T.} \text{ and } V_{H};$  where  $V_{T+}$  and  $V_{T-}$  are between limits of 20% and 70%

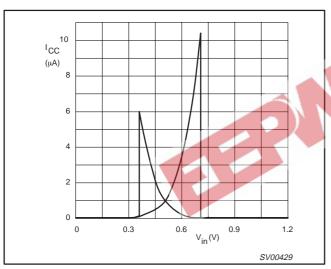


Figure 3. Typical 74LV14 transfer characteristics;  $V_{CC} = 1.2V$ .

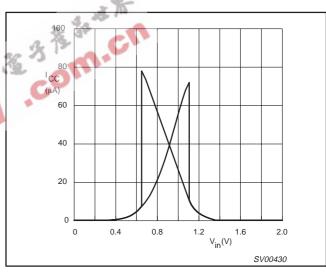


Figure 4. Typical 74LV14 transfer characteristics;  $V_{CC} = 2.0V$ .

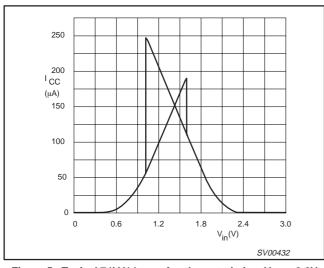


Figure 5. Typical 74LV14 transfer characteristics;  $V_{CC} = 3.0V$ .

### **AC WAVEFORMS**

 $V_{M} = 1.5 \text{ V at } V_{CC} \ge 2.7 \text{ V};$ 

 $V_{M}=0.5\times V_{CC}$  at  $V_{CC}<2.7~V$   $V_{OL}$  and  $V_{OH}$  are the typical output voltage drop that occur with the output load.

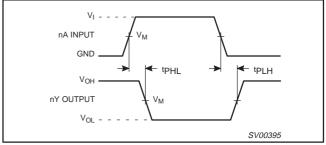


Figure 6. Input (nA) to output (nY) propagation delays.

# Hex inverting Schmitt-trigger

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### **APPLICATION INFORMATION**

The slow input rise and fall times cause additional power dissipation, this can be calculated using the following formula:

$$\mathsf{P}_{ad} \quad = \mathsf{f}_{\mathsf{i}} \times (\mathsf{t}_{\mathsf{r}} \times \mathsf{I}_{\mathsf{CCa}} + \mathsf{t}_{\mathsf{f}} \times \mathsf{I}_{\mathsf{CCa}}) \times \mathsf{V}_{\mathsf{CC}}.$$

### Where:

 $P_{ad}$  = additional power dissipation ( $\mu W$ )

f<sub>i</sub> = input frequency (MHz)

 $\begin{array}{ll} t_r & = \text{input rise time (ns); } 10\% - 90\% \\ t_f & = \text{input fall time (ns); } 10\% - 90\% \end{array}$ 

 $I_{CCa}$  = average additional supply current ( $\mu$ A)

Average  $I_{\rm CC_a}$  differs with positive or negative input transitions, as shown in Figure 7.

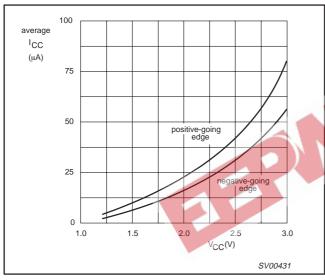


Figure 7. Average I $_{\rm CC}$  for LV Schmitt-trigger devices; linear change of V $_{\rm I}$  between 0.1 V $_{\rm CC}$  to 0.9 V $_{\rm CC}$ .

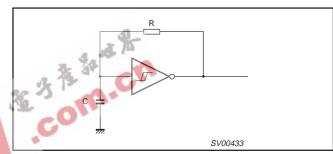


Figure 8. Relaxation oscillator using the LV14.

### Note to application information:

All values given are typical unless otherwise specified. Note to Figure 8

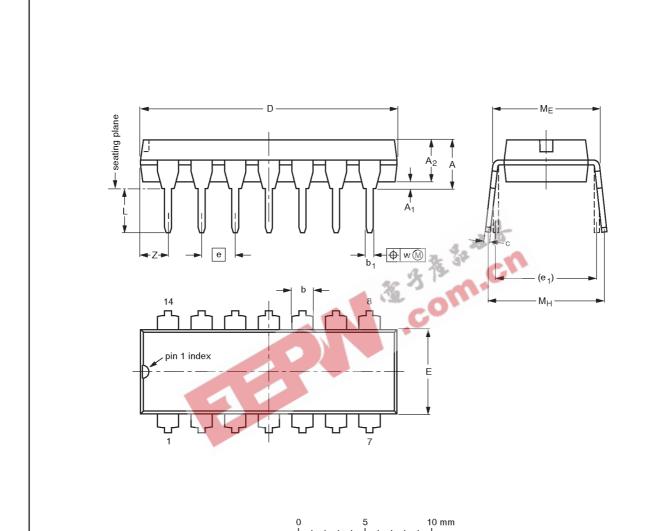
$$f = \frac{1}{T} \approx \frac{1}{0.8 \times RC}$$

# Hex inverting Schmitt-trigger

74LV14

### DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	M <sub>E</sub>	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

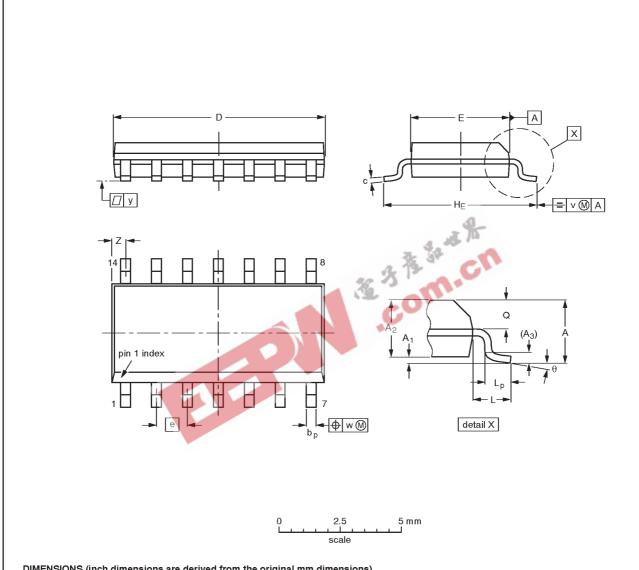
OUTLINE VERSION		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1330E DATE	
SOT27-1	050G04	MO-001AA				<del>92-11-17</del> 95-03-11	

# Hex inverting Schmitt-trigger

74LV14

### plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

DINILIAO																		
UNIT	A max.	Α1	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069			0.01	ı	0.0098 0.0075	0.35 0.34	0.16 0.15	0.050	0.24 0.23	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

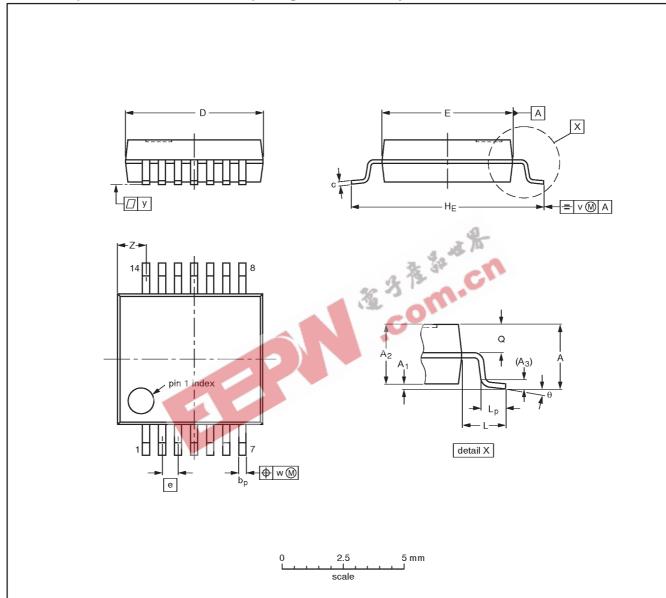
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VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT108-1	076E06\$	MS-012AB				<del>91-08-13-</del> 95-01-23	

# Hex inverting Schmitt-trigger

74LV14

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



### DIMENSIONS (mm are the original dimensions)

	(					-,												
UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	<b>A</b> <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.4 0.9	8° 0°

### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

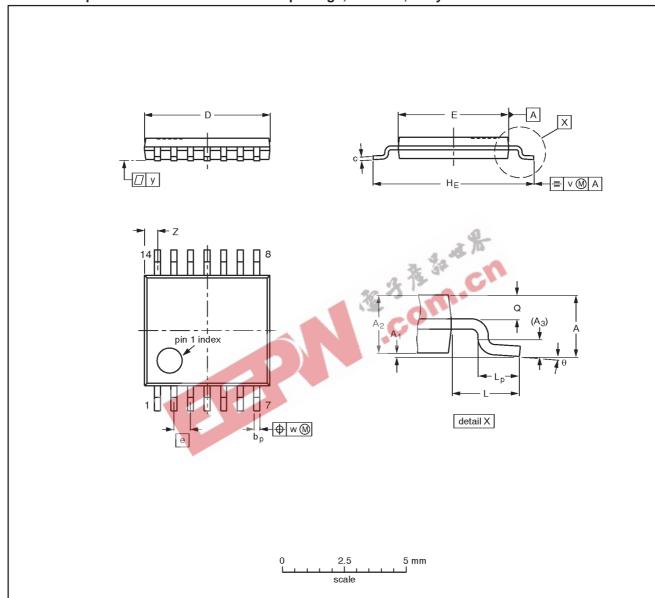
OUTLINE		EUROPEAN	ISSUE DATE				
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT337-1		MO-150AB				<del>-95-02-04</del> 96-01-18	

# Hex inverting Schmitt-trigger

74LV14

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



### DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A <sub>2</sub>	А3	bр	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		EUROPEAN	ISSUE DATE				
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1550E DATE	
SOT402-1		MO-153				<del>94-07-12</del> 95-04-04	

### Hex inverting Schmitt-trigger

74LV14



		DEFINITIONS
Data Sheet Identification	Product Status	Definition
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product Specification	Full <b>Product</b> ion	This data sheet contains Final Specifications. Philips Semiconductors reserves the right to make changes at any time without notice, in order to improve design and supply the best possible product.

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print code Date of release: 05-96

9397-750-04409 Document order number:

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